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July 11, 2003

Honorable Commissioner for Patents  
 PO Box 1450,  
 Alexandria, VA 22313

Atty. Docket No.: P68988US0  
 CUSTOMER NUMBER: 00136

Sir:

Transmitted herewith for filing is the patent application in the names of:

Sung-Kwon LEE of Ichon-shi, Republic of Korea;  
 Min-Suk Lee of Ichon-shi, Republic of Korea; and  
 Sang-Ik KIM of Ichon-shi, Republic of Korea,

for **METHOD FOR FABRICATING SEMICONDUCTOR DEVICE**. The application comprises a 27-page specification including 15 claims (3 independents) and Abstract, 11 sheets of drawings (Figs. 1A-6D), and a Declaration and Power of Attorney.

Accompanying this application for filing are:

- (1) Assignment document, cover sheet and \$40.00 fee for recordation of Assignment; and
- (2) Certified copy of Korean Application No. 2002-84231, filed December 26, 2002, Certified copy of Korean Application No. 2002-84493, filed December 26, 2002 and Certified copy of Korean Application No. 2002-84502, filed December 26, 2002, the priorities of which are claimed under 35 U.S.C. §119.

The filing fee has been calculated as shown:

Large Entity		\$ 750.00
Total Claims=15;	in excess of 20 = 0 x (\$18.00) =	
Total Ind. Claims=3;	in excess of 03 = 0 x (\$84.00) =	+
TOTAL FILING FEE:		\$ 750.00

A check in the amount of \$790.00, is enclosed to cover the total Filing Fee and an Assignment Recordation Fee. The Commissioner is hereby authorized to charge payment of any fees set forth in Sections 1.16 or 1.17 during the pendency of this application, or credit any overpayment, to deposit Account No. 06-1358. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

By: Jonathan L. Scherer Reg. No. 29,551  
 Yoon S. Ham, Reg. No. 45,307

YSH:kyc  
 Enclosures